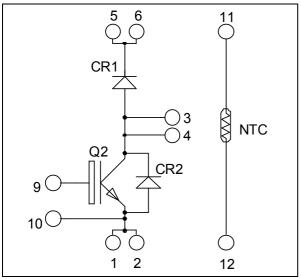
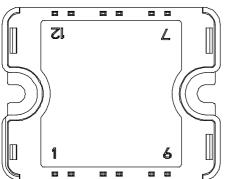


Boost chopper Trench + Field Stop IGBT3 Power Module





Pins 1/2; 3/4; 5/6 must be shorted together

$V_{CES} = 600V$ $I_{C} = 75A$ (a) $Tc = 80^{\circ}C$

Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

Features

- Trench + Field Stop IGBT3 Technology
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 20 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - RBSOA and SCSOA rated
- Very low stray inductance
- Internal thermistor for temperature monitoring
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V _{CES}	Collector - Emitter Breakdown Voltage		600	V
I.	Continuous Collector Current	$T_C = 25^{\circ}C$	100	
IC	I _C Continuous Collector Current	$T_C = 80^{\circ}C$	75	Α
I _{CM}	Pulsed Collector Current	$T_C = 25^{\circ}C$	140	
V _{GE}	Gate – Emitter Voltage		±20	V
PD	Maximum Power Dissipation	$T_C = 25^{\circ}C$	250	W
RBSOA	Reverse Bias Safe Operating Area	$T_{\rm J} = 150^{\circ}{\rm C}$	150A @ 550V	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

www.microsemi.com



All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

Electrical Characteristics									
Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit			
I _{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0V, V_{CE} = 600V$			250	μA			
V _{CE(sat)}	Collector Emitter Saturation Voltage	$V_{GE} = 15V$ $T_j = 25^{\circ}C$		1.5	1.9	V			
V CE(sat)	Concetor Emitter Saturation Voltage	$I_{\rm C} = 75 \text{A} \qquad T_{\rm j} = 150^{\circ} \text{C}$		1.7		v			
V _{GE(th)}	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 600 \mu A$	5.0	5.8	6.5	V			
I _{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20V, V_{CE} = 0V$			600	nA			

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit		
Cies	Input Capacitance	$V_{GE} = 0V$			4620			
C _{oes}	Output Capacitance	$V_{CE} = 25V$			300		pF	
C _{res}	Reverse Transfer Capacitance	f = 1 MHz		140				
T _{d(on)}	Turn-on Delay Time	Inductive Switching (25°C)			110			
T _r	Rise Time	$V_{GE} = \pm 15V$			45		ns	
T _{d(off)}	Turn-off Delay Time	$V_{Bus} = 300V$ $I_C = 75A$			200			
T _f	Fall Time	$R_G = 4.7\Omega$			40			
T _{d(on)}	Turn-on Delay Time	Inductive Switch $V_{GE} = \pm 15V$	ning (150°C)		120			
Tr	Rise Time	$V_{GE} = \pm 13 V$ $V_{Bus} = 300 V$			50		ns	
T _{d(off)}	Turn-off Delay Time	$I_{\rm C} = 75 \text{A}$ $R_{\rm G} = 4.7 \Omega$				250		
T _f	Fall Time				60			
Б	Tum on Switching Energy	$V_{GE} = \pm 15V$	$T_j = 25^{\circ}C$		0.35		mJ	
Eon	Turn-on Switching Energy	$V_{Bus} = 300V$	$T_{j} = 150^{\circ}C$		0.6		111J	
Б	Turn-off Switching Energy	$I_{\rm C} = 75 \text{A}$	$T_j = 25^{\circ}C$		2.2		mJ	
E _{off}	run-on Switching Energy	$R_G = 4.7\Omega$	$T_{j} = 150^{\circ}C$		2.6		111J	

Chopper diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit	
V _{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V	
I _{RM}	Maximum Reverse Leakage Current	V _R =600V	$T_j = 25^{\circ}C$			250	μA	
*Kivi		· K COOV	$T_{j} = 150^{\circ}C$			500	per 1	
$I_{\rm F}$	DC Forward current		$Tc = 80^{\circ}C$		75		А	
V _F	Diode Forward Voltage	$I_{\rm F} = 75 A$ $V_{\rm GE} = 0 V$	$T_i = 25^{\circ}C$		1.6	2		
▼ F	Blode i of ward Voltage		$T_i = 150^{\circ}C$		1.5		V	
t _{rr}	Reverse Recovery Time	1 754	$T_j = 25^{\circ}C$		100		ns	
чт	The verse receivery Time		$T_{i} = 150^{\circ}C$		150		115	
0	Reverse Recovery Charge	$ I_F = 75A V_R = 300V di/dt = 2000A/\mu s $	$T_j = 25^{\circ}C$		3.6		μC	
Q _{rr}	Reverse Recovery Charge				$T_{j} = 150^{\circ}C$		7.6	
Er	Reverse Recovery Energy		$T_i = 25^{\circ}C$		0.85		mJ	
Ľr	Reverse Recovery Energy		$T_{j} = 150^{\circ}C$		1.8		1113	

www.microsemi.com



Thermal and package characteristics

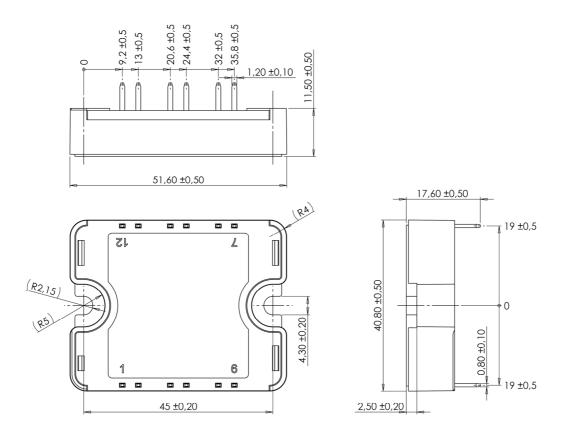
Symbol	Characteristic			Min	Тур	Max	Unit
R _{thJC}	lunction to Case Thermal Resistance	IGBT		0.60	0.60	°C/W	
		Diode			0.98		
V _{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
T _J	Operating junction temperature range			-40		175	
T _{STG}	Storage Temperature Range			-40		125	°C
T _C	Operating Case Temperature -40 100						
Torque	Mounting torque	To heatsink	M4	2		3	N.m
Wt	Package Weight					80	g

Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic	Min	Тур	Max	Unit
R ₂₅	Resistance @ 25°C		50		kΩ
B 25/85	$T_{25} = 298.15 \text{ K}$		3952		K

$$R_{T} = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$
 T: Thermistor temperature
R_T: Thermistor value at T

SP1 Package outline (dimensions in mm)



See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

www.microsemi.com

3 - 6

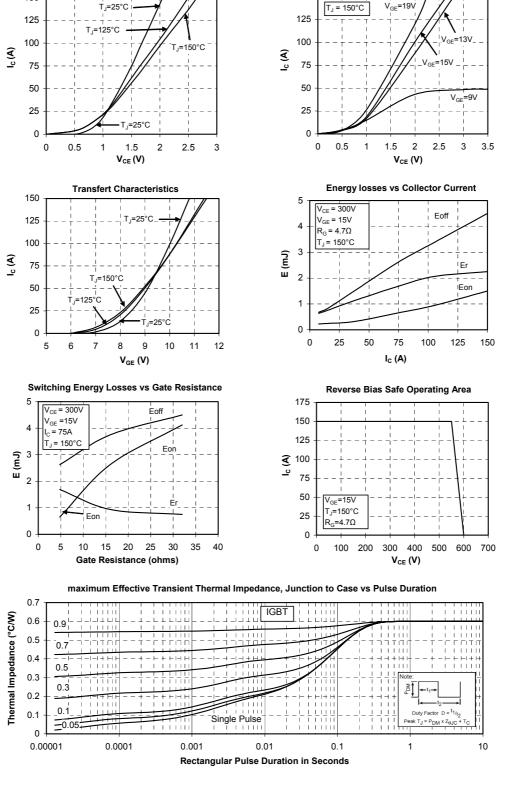


Output Characteristics (V_{GE}=15V)

Typical Performance Curve

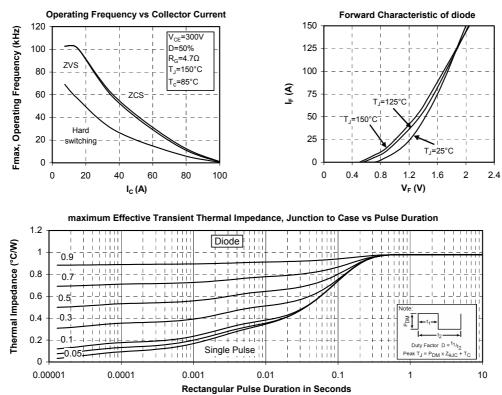
150

APTGT75DA60T1G



4 - 6





www.microsemi.com



DISCLAIMER

The information contained in the document (unless it is publicly available on the Web without access restrictions) is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi. If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with lifesupport or other mission-critical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Any performance specifications believed to be reliable but are not verified and customer or user must conduct and complete all performance and other testing of this product as well as any user or customers final application. User or customer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the customer's and user's responsibility to independently determine suitability of any Microsemi product and to test and verify the same. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the User. Microsemi specifically disclaims any liability of any kind including for consequential, incidental and punitive damages as well as lost profit. The product is subject to other terms and conditions which can be located on the web at http://www.microsemi.com/legal/tnc.asp

Life Support Application

Seller's Products are not designed, intended, or authorized for use as components in systems intended for space, aviation, surgical implant into the body, in other applications intended to support or sustain life, or for any other application in which the failure of the Seller's Product could create a situation where personal injury, death or property damage or loss may occur (collectively "Life Support Applications").

Buyer agrees not to use Products in any Life Support Applications and to the extent it does it shall conduct extensive testing of the Product in such applications and further agrees to indemnify and hold Seller, and its officers, employees, subsidiaries, affiliates, agents, sales representatives and distributors harmless against all claims, costs, damages and expenses, and attorneys' fees and costs arising, directly or directly, out of any claims of personal injury, death, damage or otherwise associated with the use of the goods in Life Support Applications, even if such claim includes allegations that Seller was negligent regarding the design or manufacture of the goods.

Buyer must notify Seller in writing before using Seller's Products in Life Support Applications. Seller will study with Buyer alternative solutions to meet Buyer application specification based on Sellers sales conditions applicable for the new proposed specific part.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for IGBT Modules category:

Click to view products by Microsemi manufacturer:

Other Similar products are found below :

 F3L400R07ME4_B22
 F4-50R07W2H3_B51
 FB15R06W1E3
 FB20R06W1E3_B11
 FD1000R33HE3-K
 FD400R33KF2C-K

 FD401R17KF6C_B2
 FD-DF80R12W1H3_B52
 FF200R06YE3
 FF300R12KE4_E
 FF450R12ME4P
 FF600R12IP4V
 FP10R06W1E3_B11

 FP20R06W1E3
 FP50R12KT3
 FP75R07N2E4_B11
 FS10R12YE3
 FS150R07PE4
 FS150R12PT4
 FS200R12KT4R
 FS50R07N2E4_B11

 FZ1000R33HE3
 FZ1800R17KF4
 DD250S65K3
 DF1000R17IE4
 DF1000R17IE4D_B2
 DF1400R12IP4D
 DF200R12PT4_B6

 DF400R07PE4R_B6
 BSM75GB120DN2_E3223c-Se
 F3L300R12ME4_B22
 F3L75R07W2E3_B11
 F4-50R12KS4_B11

 F475R07W1H3B11ABOMA1
 FD1400R12IP4D
 FD200R12PT4_B6
 FD800R33KF2C-K
 FF1200R17KP4_B2
 FF300R17KE3_S4

 FF300R17ME4_B11
 FF401R17KF6C_B2
 FF650R17IE4D_B2
 FF900R12IP4D
 STGIF7CH60TS-L
 FP50R07N2E4_B11

 FS100R07PE4
 FS150R07N3E4_B11
 FS150R17N3E4
 FS150R17PE4
 STGIF7CH60TS-L
 FP50R07N2E4_B11